502523859 10/08/2013

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2569050

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HYEON MIN BAE	02/25/2013
TAE HUN YOON	02/25/2013
JIN HO PARK	02/25/2013
TAE HO KIM	02/25/2013

RECEIVING PARTY DATA

Name:	KOREA ADVANCED INSTITUTE OF SCIENCE AND TECHNOLOGY	
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State/Country:	KOREA, REPUBLIC OF	
Postal Code:	Postal Code: 305-701	

Name:	TERASQUARE CO., LTD.	
Street Address:	16TH FLOOR ANNJAY TOWER, 718-2	
Internal Address:	YOKSAM DONG, KANGNAM GU	
City:	SEOUL	
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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13835530	

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PATENT

REEL: 031360 FRAME: 0641

JF \$40.00 13835530

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NAME OF SUBMITTER: AUDREY NAGELBERG

Signature: /Audrey Nagelberg/

Date: 10/08/2013

Total Attachments: 2

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> PATENT REEL: 031360 FRAME: 0642

ASSIGNMENT

Serial No: 13/835,530

Filed:

March 15, 2013

Title:

Low-power CML-less Transmitter Architecture

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign to 1. Korea Advanced Institute of Science and Technology (373-1 Guseong-dong, Yuseong-gu, Daejeon 305-701 Republic of Korea) and: 2. TeraSquare Co., Ltd.(16th floor Anniay Tower, 718-2, Yoksam Dong, Kangnam Gu, 135-920, Seoul, Republic of Korea), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for letters patent of the United States, executed by the undersigned on, and in said application and any and all other applications, both in the United States and in other countries, which the undersigned may file or be named as an inventor, either solely or jointly with others, on said invention or improvements, and in any and all letters patent of the United States and other countries, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize and request the Commissioner for Patents to issue said letters patent to said Assignee.

The undersigned hereby authorize and request that the attorneys of record in said application insert in this assignment the execution date and/or filing date and serial number of said application when officially known.

The undersigned warrant themselves to be the owners of the interest herein assigned and to have the right to make this assignment and further warrant that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned except in favor of Assignee.

For said consideration the undersigned hereby agree, upon the request and at the expense of said Assignee, its successors and assigns, to execute any and all applications on said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any letters patent that may be granted upon any and all of said applications, and any and all applications and other documents for letters patent in other countries on said invention or improvements, that said Assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agree upon the request of said Assignee, its successors or assigns, in the event of any application or letters patent assigned herein becoming involved in Interference or Opposition, to cooperate to the best of the ability of the undersigned with said Assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and undersigned hereby agreeing to perform, producing evidence in support thereof, the

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upon request, any and all affirmative acts to obtain said letters patent, both in the United States and in other countries, and vest all rights therein hereby conveyed in said Assignee, its successors and assigns, whereby said letters patent will be held and enjoyed by said Assignee, its successors and assigns, to the full end of the term for which said letters patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

Date:	02/25/2013	Signature:	First Inventor - Hyeon Min BAE
Date:	2013-02-25	Signature:	Second inventor – Tae hun YOON
Date:	2/25/2013	Signature:	Third inventor – Jin ho PARK
Date:	2/25/2013	Signature:	Tacho (Cm. Fourth inventor - Tae ho KIM